

Features

- Side view 0602 package
- Viewing Angle = ±60°
- Compatible with infrared and vapor phase reflow solder process
- High reliability
- Ultra bright Yellow
- RoHS compliance

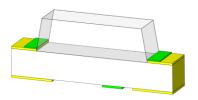
Applications

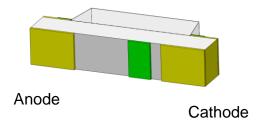
- Optical indicator.
- Switch and Symbol Display.

Description

The YP160306-CSC3 is an AlGaInP Yellow LED housed in a miniature SMD package. The device has a dominant wavelength of 590nm LED.

Package Outline





Schematic



Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
lF	Continuous Forward Current	25	mA	
I _{FP}	Peak Forward Current	60	mA	1
V _R	Reverse Voltage	5	V	
Topr	Operating Temperature	-40 ~ +85	°С	
T _{stg}	Storage Temperature	-40 ~ +100	оС	
T _{sol}	Soldering Temperature	260	°С	2
PD	Power Dissipation at(or below) 25°C Free Air Temperature	60	mW	

Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

Optical Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I _F =5mA	18.5	-	45	mcd	3
λр	Peak Wavelength	I _F =5mA	-	599	-	nm	
λd	Dominant Wavelength	I _F =5mA	582.5	-	594.5	nm	4
θ1/2	Angle of Half Intensity	I _F =5mA	-	±60	-	deg	

Electrical Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward Voltage	I _F =5mA	1.7	-	2.2	V	5
I _R	Reverse Current	V _R =5V	-	-	1	μΑ	

Notes:

- 1. I_{FP} Conditions--Pulse Width≦ 100µs and Duty≦ 10%.
- 2. Soldering time≤ 10 seconds.
- 3. Bin Range of Luminous Intensity

Bin Code	Min	Max	Unit	Condition	
M1	18.0	22.5			
M2	22.5	28.5	mad	I _F =5mA	
N1	28.5	36.0	mcd		
N2	36.0	45.0			

Tolerance of: Luminous Intensity $\pm 10\%$



4. Bin Range of Dominant Wavelength

Bin Code	Min	Max	Unit	Condition	
Y2	582.5	585.5		I _F =5mA	
Y3	585.5	588.5			
Y4	588.5	591.5	nm		
Y5	591.5	594.5			

Tolerance of Dominant Wavelength: $\pm 1\,\text{nm}$.

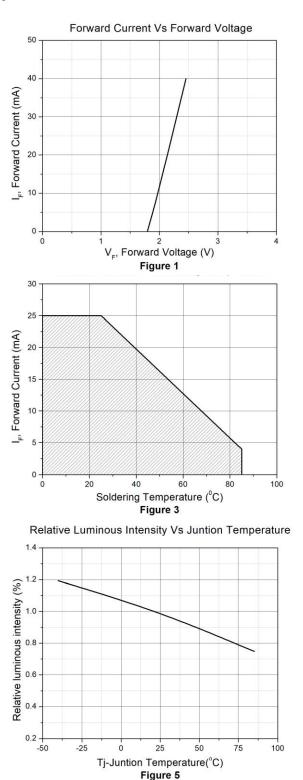
5. Bin Range of Forward Voltage

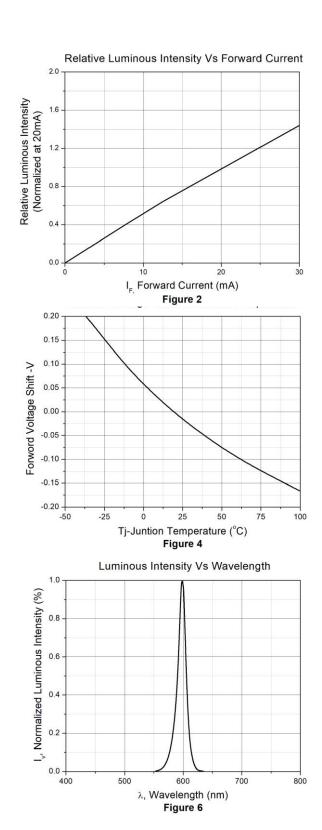
Bin Code	Min	Max	Unit	Condition
24	1.7	1.8		
25	1.8	1.9		
26	1.9	2.0	V	I _F =5mA
27	2.0	2.1		
28	2.1	2.2		

Tolerance of Forward Voltage ± 0.05 V.



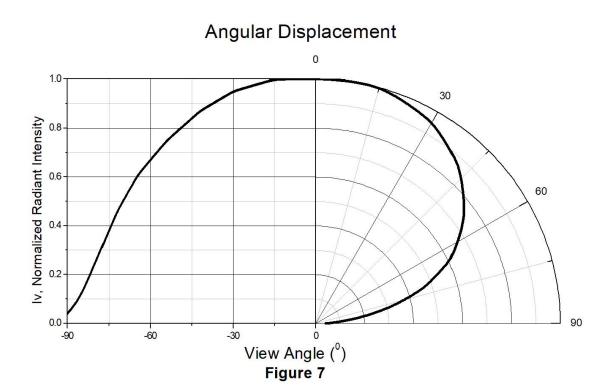
Typical Characteristic Curves





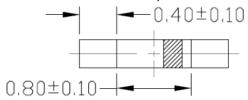


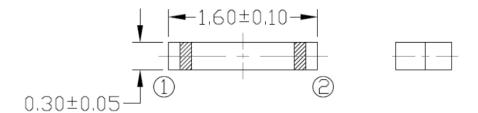
Typical Characteristic Curves

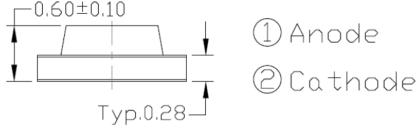




Package Dimension All dimensions are in mm, unless otherwise stated

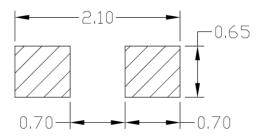






Note: Tolerance unless mentioned is ±0.1mm.

Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



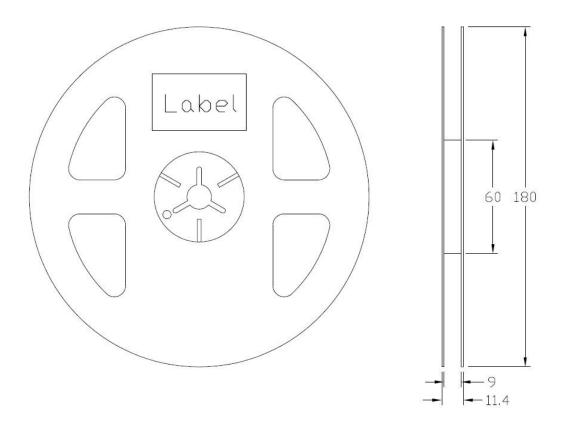
Note: Tolerance unless mentioned is ±0.1mm.

Ordering Information

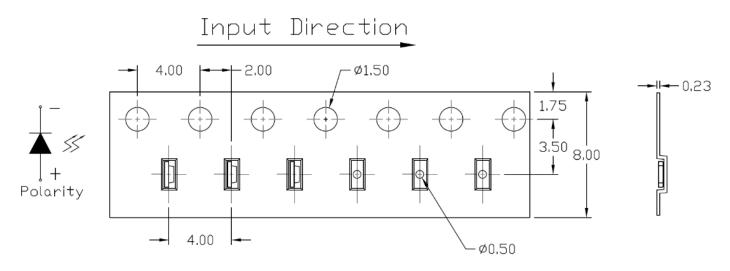
Part Number	Description	Quantity
YP160306-CSC3	Tape & Reel	3000 pcs



Reel Dimension All dimensions are in mm, unless otherwise stated



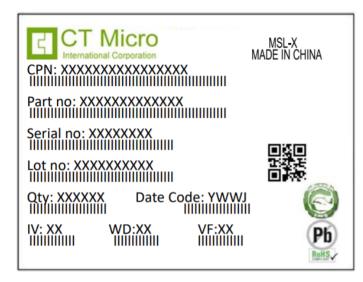
Tape Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm.



Label Form Specification



CPN : Customer Part Number Part no: CTM Production Number

Serial no: Production Number

Lot no: Lot number

Q'ty: Packing Quantity

Date Code: Manufacture Date IV: Bin Code of Luminous Intensity

WD : Bin Code of Dominant Wavelength

VF : Bin Code of Forward Voltage

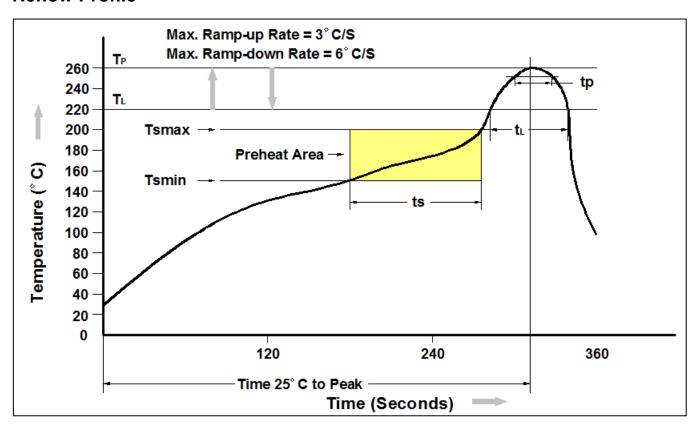
MADE IN CHINA: Production Place

Storage Condition

- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 1 year at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t _L to t _P)	3°C/second max.
Liquidous Temperature (T _L)	217°C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of 260°C	30 seconds
Ramp-down Rate (T _P to T _L)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



DISCLAIMER

CT MICRO RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. CT MICRO DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

CT MICRO ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR

CT MICRO ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OF SYSTEMS WITHOUT EXPRESS WRITTEN APPROVAL OF CT MICRO INTERNATIONAL CORPORATION.

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instruction for use provided in the labelling, can be reasonably expected to result in significant injury to the user.
- A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.